

E-beam (Angstrom) deposition - Depositing

metal layers: **Ti, Cr, Al, Ni, Cu, Pt**

- Samples : 5 x 4" Wafers or Equivalent Area
- Crucible Size: 3.6 cc (interior volume)
- 8 pocket rotary holder
- Base Pressure $\sim 2 \times 10^{-6}$ Torr
- Pump Time ~ 30 minutes

